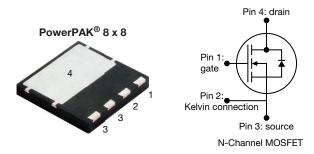
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Vishay Siliconix

HALOGEN

FREE GREEN

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.061				
Q _g max. (nC)	7	75			
Q _{gs} (nC)	20				
Q _{gd} (nC)	17				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SiHH070N60EF-T1GE3

ABSOLUTE MAXIMUM RATINGS (7	√ _C = 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	600	V
Gate-source voltage			V_{GS}	± 30]
Continuous dusin suurent /T 150 °C)	V _{GS} at 10 V	T _C = 25 °C	- I _D	36	А
Continuous drain current (T _J = 150 °C)	VGS at 10 V	T _C = 100 °C		23	
Pulsed drain current ^a			I _{DM}	93	1
Linear derating factor				1.6	W/°C
Single pulse avalanche energy b			E _{AS}	226	mJ
Maximum power dissipation			P _D	202	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope T _J = 125 °C			dv/dt	100	V/ns
Reverse diode dv/dt ^d				50	1 v/ns

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, di/dt = 900 A/ μ s, starting T_J = 25 °C



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THERMAL RESISTANCE RATINGS						
PARAMETER SYMBOL TYP. MAX. UNIT						
Maximum junction-to-ambient	R_{thJA}	38	50	°C/W		
Maximum junction-to-case (drain)	R_{thJC}	0.48	0.62	C/ VV		

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 20 mA	-	0.51	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3	-	5	V
Coto pouros logicoro	I _{GSS}	,	$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
Gate-source leakage		,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zava sata valtasa duain ayuwant		V _{DS} =	480 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 15 A	-	0.061	0.071	Ω
Forward transconductance a	9 _{fs}	V _{DS}	= 20 V, I _D = 15 A	-	10.5	-	S
Dynamic					•		
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	2647	-	
Output capacitance	C _{oss}	,	$V_{DS} = 100 \text{ V},$	-	122	-	1
Reverse transfer capacitance	C _{rss}		f = 1 MHz		6	-	pF
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	90	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	560	-	
Total gate charge	Qg			-	50	75	
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 15 A, V _{DS} = 480 V		-	20	-	nC
Gate-drain charge	Q _{gd}			-	17	-	1
Turn-on delay time	t _{d(on)}			-	36	72	
Rise time	t _r	V _{DD} = 480 V, I _D = 15 A,		-	79	119	1 .
Turn-off delay time	t _{d(off)}		$= 10 \text{ V}, \text{ R}_{\text{g}} = 9.1 \Omega$	-	55	83	ns
Fall time	t _f			-	38	76	
Gate input resistance	R_g		f = 1 MHz	0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET sym showing the	bol	-	-	36	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	93	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}			-	136	272	ns
Reverse recovery charge	Q _{rr}		$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 15 \text{A},$		0.9	1.8	μC
Reverse recovery current	I _{RRM}	di/dt = 100 A/μs, V _R = 400 V			12	_	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

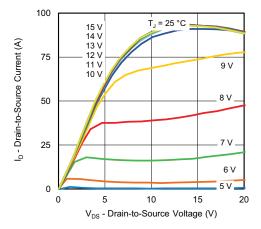


Fig. 1 - Typical Output Characteristics

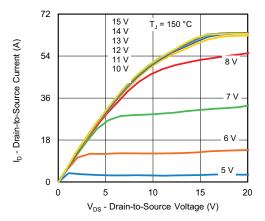


Fig. 2 - Typical Output Characteristics

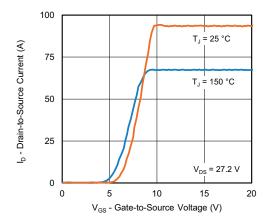


Fig. 3 - Typical Transfer Characteristics

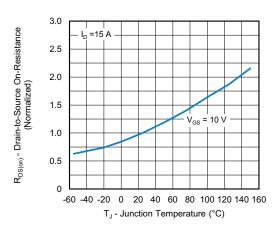


Fig. 4 - Normalized On-Resistance vs. Temperature

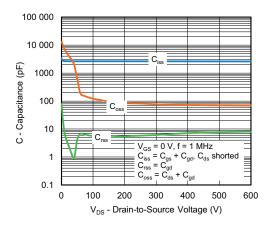


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

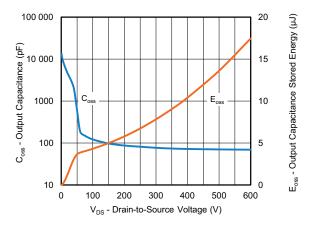


Fig. 6 - Coss and Eoss vs. VDS



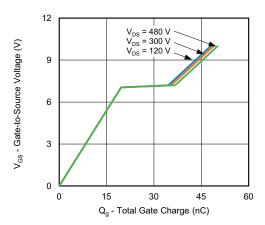


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

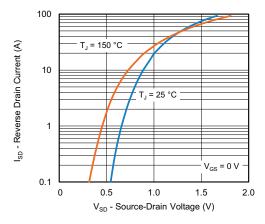


Fig. 8 - Typical Source-Drain Diode Forward Voltage

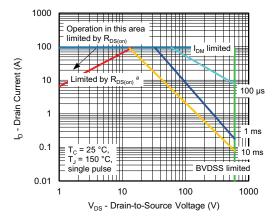


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

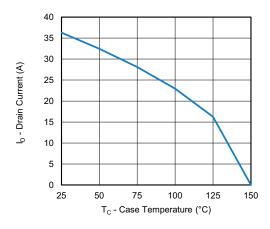


Fig. 10 - Maximum Drain Current vs. Case Temperature

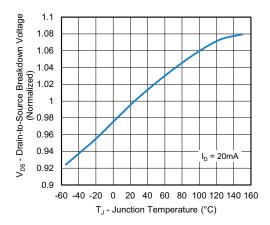


Fig. 11 - Temperature vs. Drain-to-Source Voltage



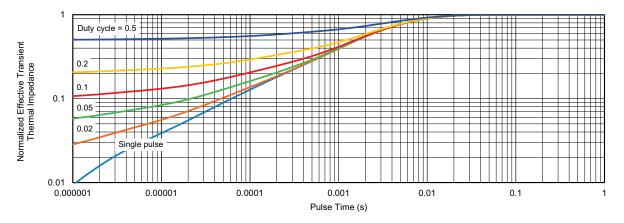


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

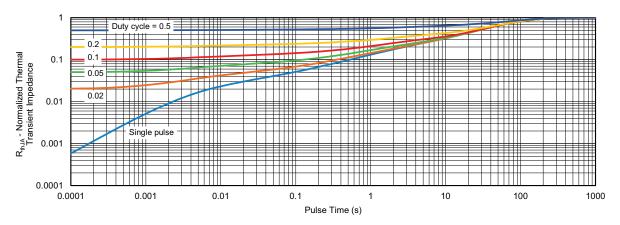


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

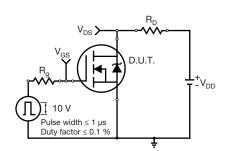


Fig. 14 - Switching Time Test Circuit

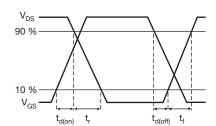


Fig. 15 - Switching Time Waveforms

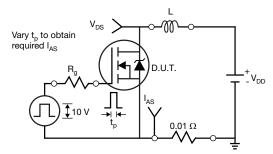


Fig. 16 - Unclamped Inductive Test Circuit

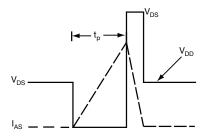


Fig. 17 - Unclamped Inductive Waveforms

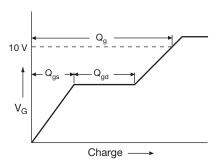


Fig. 18 - Basic Gate Charge Waveform

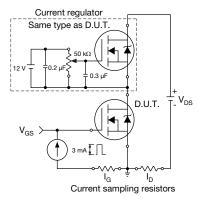
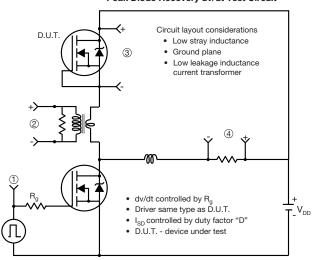


Fig. 19 - Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



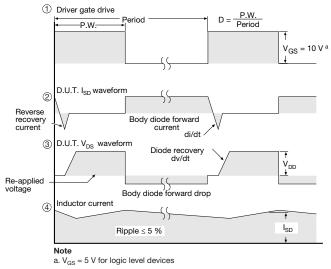


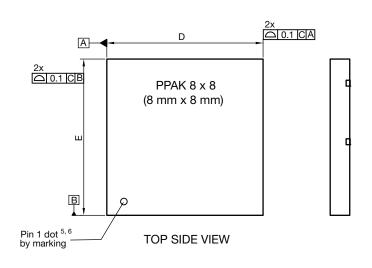
Fig. 20 - For N-Channel

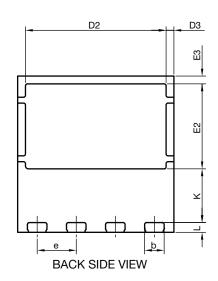
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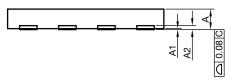


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PowerPAK® 8 x 8 Case Outline







DIM.	MILLIMETERS			INCHES			
DIIVI.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2	020 ref.			0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3	0.40 BSC			0.016 BSC			
е	2.00 BSC		0.079 BSC				
Е	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3		0.40 BSC			0.016 BSC		
K	2.75 BSC		2.75 BSC 0.108 BSC		0.108 BSC		
L	0.45	0.50	0.55	0.018	0.020	0.022	
N ⁽³⁾	8				8		

Notes

- (1) Use millimeters as the primary measurement
- (2) Dimensioning and tolerances conform to ASME Y14.5 M 1994
- (3) N is the number of terminals
- (4) The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body
- (5) Exact shape and size of this feature is optional

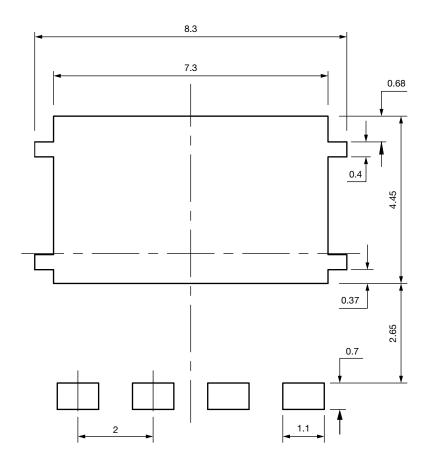
ECN: E20-0518-Rev. B, 28-Sep-2020

DWG: 6041

Revision: 28-Sep-2020 1 Document Number: 67859



Recommended Minimum PADs for PowerPAK® 8 mm x 8 mm



Dimensions in millimeters



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